



PGA204
PGA205

Programmable Gain INSTRUMENTATION AMPLIFIER

FEATURES

- **DIGITALLY PROGRAMMABLE GAIN:**
PGA204: $G=1, 10, 100, 1000V/V$
PGA205: $G=1, 2, 4, 8V/V$
- **LOW OFFSET VOLTAGE:** $50\mu V$ max
- **LOW OFFSET VOLTAGE DRIFT:** $0.25\mu V/^{\circ}C$
- **LOW INPUT BIAS CURRENT:** $2nA$ max
- **LOW QUIESCENT CURRENT:** $5.2mA$ typ
- **NO LOGIC SUPPLY REQUIRED**
- **16-PIN PLASTIC DIP, SOL-16 PACKAGES**

APPLICATIONS

- **DATA ACQUISITION SYSTEM**
- **GENERAL PURPOSE ANALOG BOARDS**
- **MEDICAL INSTRUMENTATION**

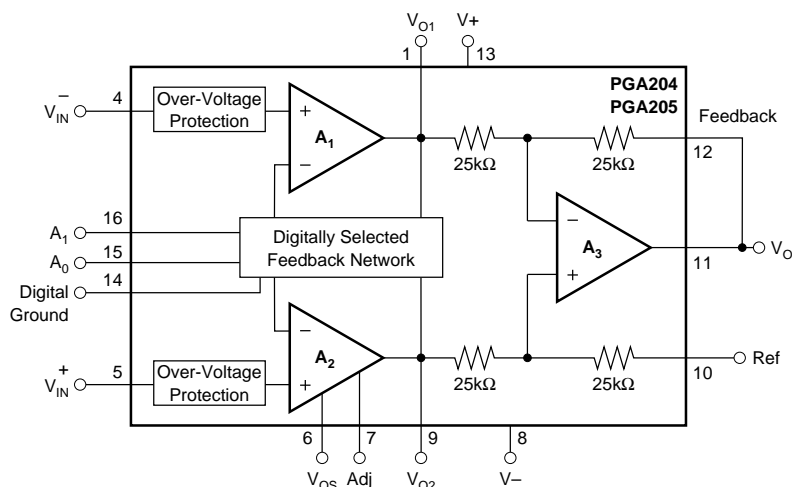
DESCRIPTION

The PGA204 and PGA205 are low cost, general purpose programmable-gain instrumentation amplifiers offering excellent accuracy. Gains are digitally selected: PGA204—1, 10, 100, 1000, and PGA205—1, 2, 4, 8V/V. The precision and versatility, and low cost of the PGA204 and PGA205 make them ideal for a wide range of applications.

Gain is selected by two TTL or CMOS-compatible address lines, A_0 and A_1 . Internal input protection can withstand up to $\pm 40V$ on the analog inputs without damage.

The PGA204 and PGA205 are laser trimmed for very low offset voltage ($50\mu V$), drift ($0.25\mu V/^{\circ}C$) and high common-mode rejection (115dB at $G=1000$). They operate with power supplies as low as $\pm 4.5V$, allowing use in battery operated systems. Quiescent current is 5mA.

The PGA204 and PGA205 are available in 16-pin plastic DIP, and SOL-16 surface-mount packages, specified for the $-40^{\circ}C$ to $+85^{\circ}C$ temperature range.



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ELECTRICAL

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, and $R_I = 2\text{k}\Omega$ unless otherwise noted.

* Specification same as PGA204BP.

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SPECIFICATIONS

ELECTRICAL

PGA205 G=1, 2, 4, 8V/V

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{V}$, and $R_L = 2\text{k}\Omega$ unless otherwise noted.

PARAMETER	CONDITIONS	PGA205BP, BU			PGA205AP, AU			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
INPUT								
Offset Voltage, RTI	$T_A = +25^\circ\text{C}$		$\pm 10 + 20/\text{G}$	$\pm 50 + 100/\text{G}$		$\pm 25 + 30/\text{G}$	$\pm 125 + 500/\text{G}$	μV
vs Temperature	$T_A = T_{\text{MIN}}$ to T_{MAX}		$\pm 0.1 + 0.5/\text{G}$	$\pm 0.25 + 5/\text{G}$		$\pm 0.25 + 5/\text{G}$	$\pm 1 + 10/\text{G}$	$\mu\text{V}/^\circ\text{C}$
vs Power Supply	$V_S = \pm 4.5\text{V}$ to $\pm 18\text{V}$		$0.5 + 2/\text{G}$	$3 + 10/\text{G}$		*	*	$\mu\text{V}/\text{V}$
Long-Term Stability			$\pm 0.2 + 0.5/\text{G}$			*		$\mu\text{V}/\text{mo}$
Impedance, Differential			$10^{10} 6$			*		ΩpF
Common-Mode			$10^{10} 6$			*		ΩpF
Input Common-Mode Range	$V_O = 0\text{V}$ (see text)	± 10.5	± 12.7		*	*		V
Safe Input Voltage				± 40			*	V
Common-Mode Rejection	$V_{\text{CM}} = \pm 10\text{V}$, $\Delta R_S = 1\text{k}\Omega$							
	G=1	80	94		75	88		dB
	G=2	85	100		80	94		dB
	G=4	90	106		85	100		dB
	G=8	95	112		89	106		dB
BIAS CURRENT			± 0.5	± 2		*	± 5	nA
vs Temperature			± 8			*		$\text{pA}/^\circ\text{C}$
Offset Current			± 0.5	± 2		*	*	nA
vs Temperature			± 8			*		$\text{pA}/^\circ\text{C}$
Noise Voltage, RTI ⁽¹⁾ : f=10Hz	G=8, $R_S = 0\Omega$		19			*		$\text{nV}/\sqrt{\text{Hz}}$
f=100Hz	G=8, $R_S = 0\Omega$		15			*		$\text{nV}/\sqrt{\text{Hz}}$
f=1kHz	G=8, $R_S = 0\Omega$		15			*		$\text{nV}/\sqrt{\text{Hz}}$
$f_B = 0.1\text{Hz}$ to 10Hz	G=8, $R_S = 0\Omega$		0.5			*		$\mu\text{Vp-p}$
Noise Current								
f=10Hz			0.4			*		$\text{pA}/\sqrt{\text{Hz}}$
f=1kHz			0.2			*		$\text{pA}/\sqrt{\text{Hz}}$
$f_B = 0.1\text{Hz}$ to 10Hz			18			*		pAp-p
GAIN, Error	G=1		± 0.005	± 0.024		*	± 0.05	%
	G=2		± 0.01	± 0.024		*	± 0.05	%
	G=4		± 0.01	± 0.024		*	± 0.05	%
	G=8		± 0.01	± 0.024		*	± 0.05	%
Gain vs Temperature	G=1 to 8		± 2.5	± 10		*	*	$\text{ppm}/^\circ\text{C}$
Nonlinearity	G=1		± 0.00024	± 0.001		*	± 0.002	% of FSR
	G=2		± 0.00024	± 0.002		*	± 0.004	% of FSR
	G=4		± 0.00024	± 0.002		*	± 0.004	% of FSR
	G=8		± 0.00024	± 0.002		*	± 0.004	% of FSR
OUTPUT								
Voltage, Positive ⁽²⁾	$I_O = 5\text{mA}$, T_{MIN} to T_{MAX}	$(V+) - 1.5$	$(V+) - 1.3$		*	*		V
Negative ⁽²⁾	$I_O = -5\text{mA}$, T_{MIN} to T_{MAX}	$(V-) + 1.5$	$(V-) + 1.3$		*	*		V
Load Capacitance Stability			1000			*		pF
Short Circuit Current			$+23/-17$			*		mA
FREQUENCY RESPONSE								
Bandwidth, -3dB	G=1		1			*		MHz
	G=2		400			*		kHz
	G=4		200			*		kHz
	G=8		100			*		kHz
Slew Rate	$V_O = \pm 10\text{V}$, G=8	0.3	0.7		*	*		V/ μs
Settling Time ⁽³⁾ , 0.1%	G=1		22			*		μs
	G=2		22			*		μs
	G=4		23			*		μs
	G=8		23			*		μs
0.01%	G=1		23			*		μs
	G=2		23			*		μs
	G=4		25			*		μs
	G=8		28			*		μs
Overload Recovery	50% overdrive		70			*		μs
DIGITAL LOGIC INPUTS								
Digital Ground Voltage, V_{DG}		V-		$(V+) - 4$	*		*	V
Digital Low Voltage		V-		$V_{\text{DG}} + 0.8\text{V}$	*		*	V
Digital Low Current			1			*		μA
Digital High Voltage		$V_{\text{DG}} + 2$		V+	*		*	V
POWER SUPPLY, Voltage		± 4.5	± 15	± 18	*	*	*	V
Current	$V_{\text{IN}} = 0\text{V}$		$+5.2/-4.2$	± 6.5		*	± 7.5	mA
TEMPERATURE RANGE								
Specification		-40		+85	*		*	$^\circ\text{C}$
Operating		-40		+125	*		*	$^\circ\text{C}$
θ_{JA}			80			*		$^\circ\text{C}/\text{W}$

* Specification same as PGA204BP.

NOTES: (1) Input-referred noise voltage varies with gain. See typical curves. (2) Output voltage swing is tested for $\pm 10\text{V}$ min on $\pm 11.4\text{V}$ power supplies. (3) Includes time to switch to a new gain.

PACKAGE INFORMATION

MODEL	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾
PGA204AP	16-Pin Plastic DIP	180
PGA204BP	16-Pin Plastic DIP	180
PGA204AU	SOL-16 Surface Mount	211
PGA204BU	SOL-16 Surface Mount	211
PGA205AP	16-Pin Plastic DIP	180
PGA205BP	16-Pin Plastic DIP	180
PGA205AU	SOL-16 Surface Mount	211
PGA205BU	SOL-16 Surface Mount	211

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

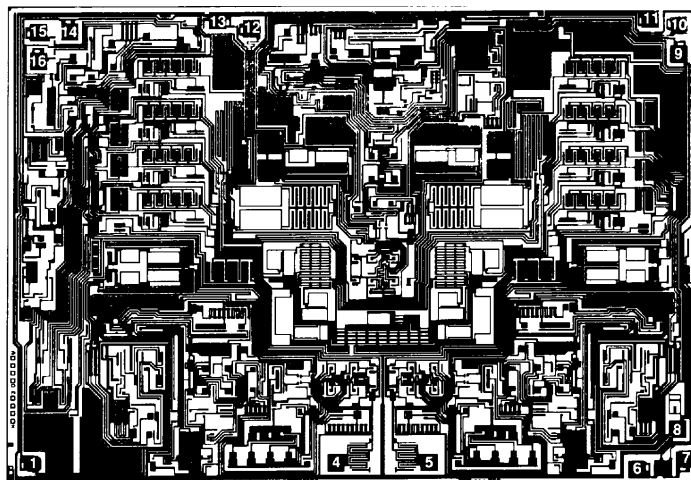
ABSOLUTE MAXIMUM RATINGS

Supply Voltage	±18V
Analog Input Voltage Range	±40V
Logic Input Voltage Range	±V _S
Output Short-Circuit (to ground)	Continuous
Operating Temperature	–40°C to +125°C
Storage Temperature	–40°C to +125°C
Junction Temperature	+150°C
Lead Temperature (soldering –10s)	+300°C

ORDERING INFORMATION

MODEL	GAINS	PACKAGE	TEMPERATURE RANGE
PGA204AP	1, 10, 100, 1000V/V	16-Pin Plastic DIP	–40 to +85°C
PGA204BP	1, 10, 100, 1000V/V	16-Pin Plastic DIP	–40 to +85°C
PGA204AU	1, 10, 100, 1000V/V	SOL-16 Surface-Mount	–40 to +85°C
PGA204BU	1, 10, 100, 1000V/V	SOL-16 Surface-Mount	–40 to +85°C
PGA205AP	1, 2, 4, 8V/V	16-Pin Plastic DIP	–40 to +85°C
PGA205BP	1, 2, 4, 8V/V	16-Pin Plastic DIP	–40 to +85°C
PGA205AU	1, 2, 4, 8V/V	SOL-16 Surface-Mount	–40 to +85°C
PGA205BU	1, 2, 4, 8V/V	SOL-16 Surface-Mount	–40 to +85°C

DICE INFORMATION



PGA204/205 DIE TOPOGRAPHY

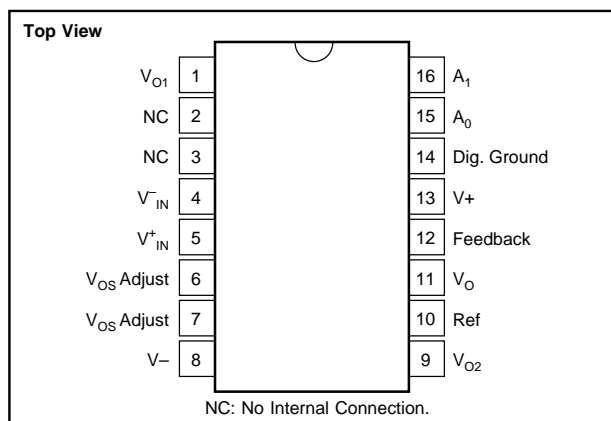
PAD	FUNCTION	PAD	FUNCTION
1	V_{O1}	9	V_{O2}
2	—	10	Ref
3	—	11	V_O
4	V_{IN}^-	12	Feedback
5	V_{IN}^+	13	V_+
6	V_{OS} Adj	14	Dig. Ground
7	V_{OS} Adj	15	A_0
8	V_-	16	A_1

Substrate Bias: Internally connected to V_- power supply.

MECHANICAL INFORMATION

	MILS (0.001")	MILLIMETERS
Die Size	186 x 130 ± 5	4.72 x 3.30 ± 0.13
Die Thickness	20 ± 3	0.51 ± 0.08
Min. Pad Size	4 x 4	0.1 x 0.1
Backing	Gold	

PIN CONFIGURATION



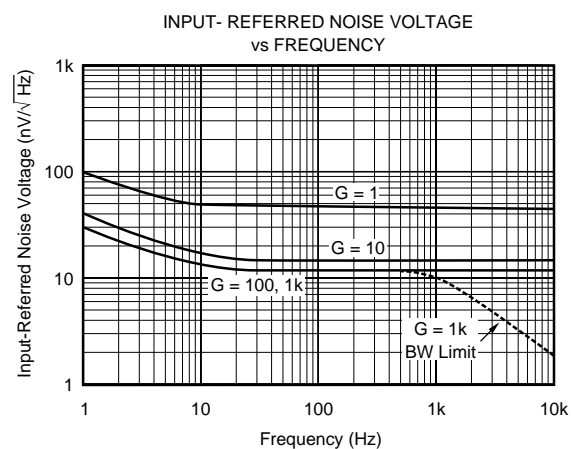
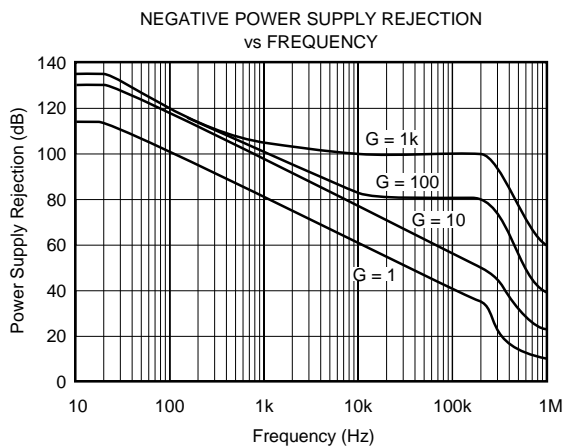
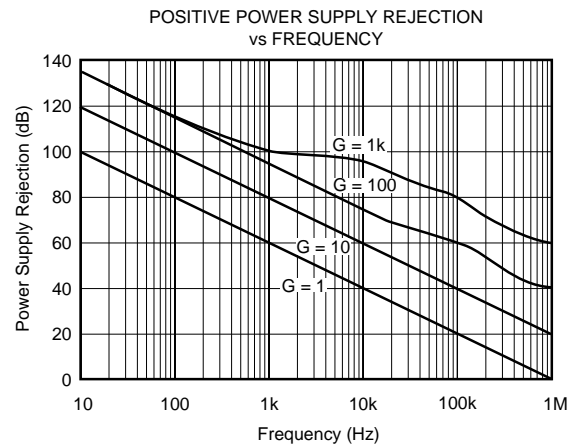
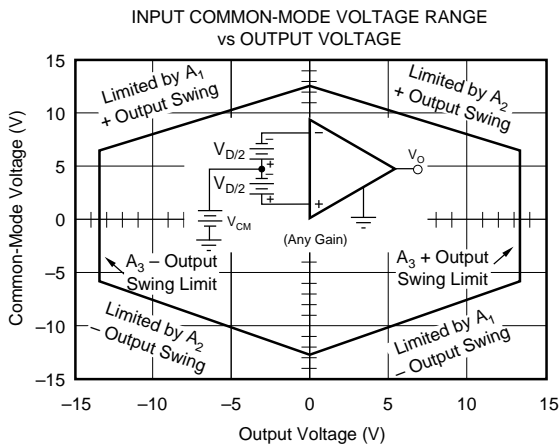
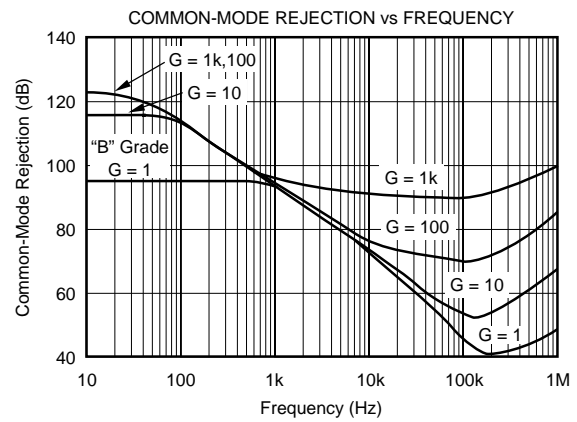
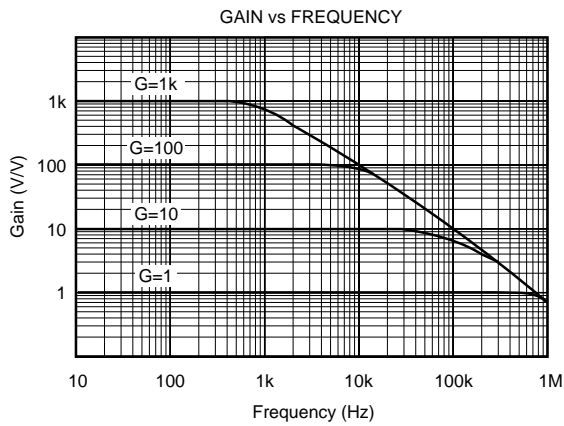
ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

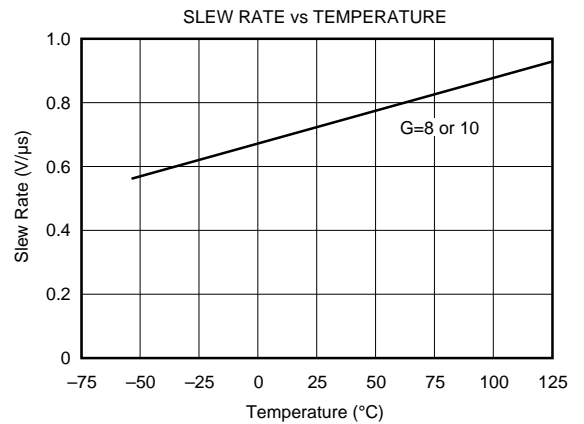
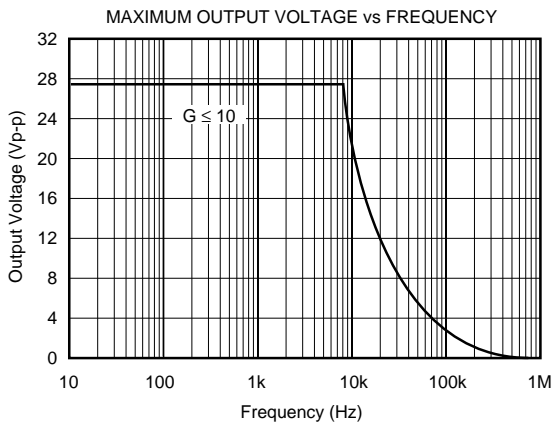
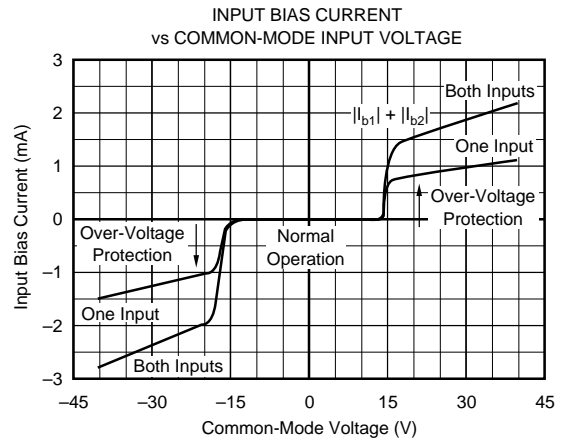
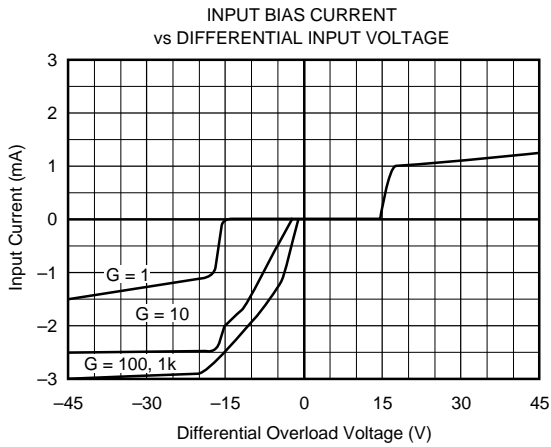
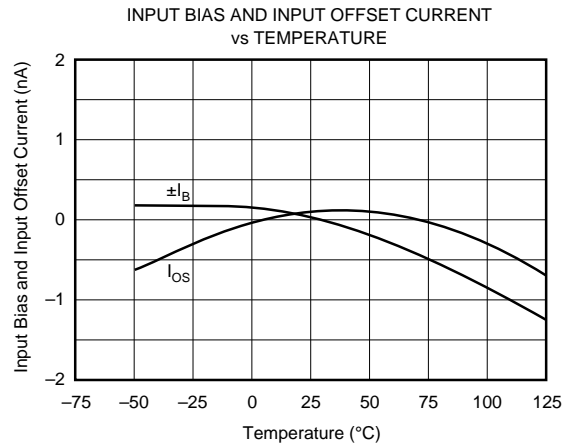
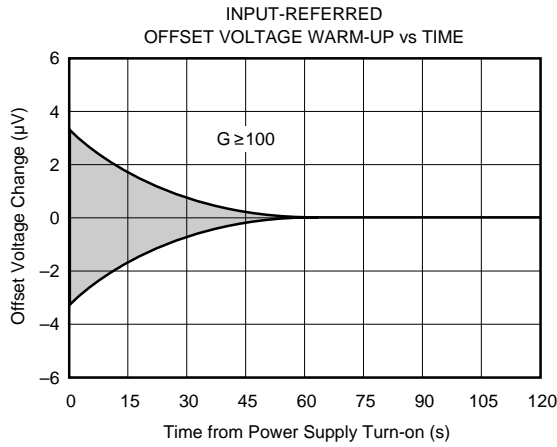
TYPICAL PERFORMANCE CURVES

At $T_A = +25^\circ\text{C}$, and $V_S = \pm 15\text{V}$, unless otherwise noted.



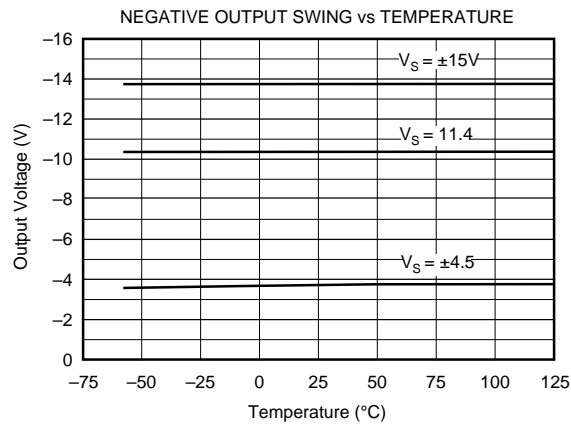
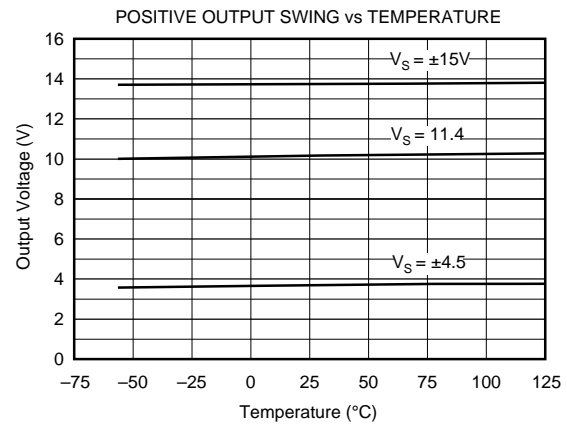
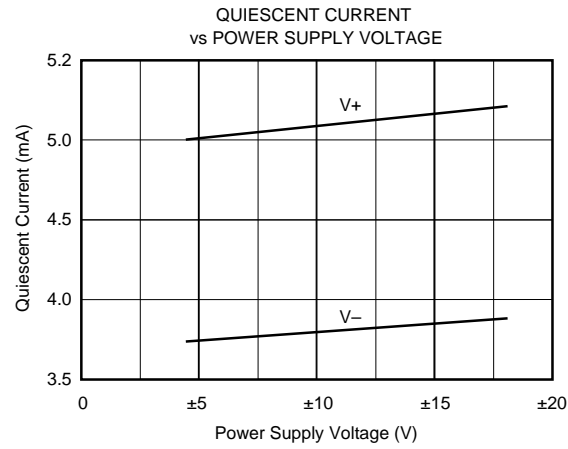
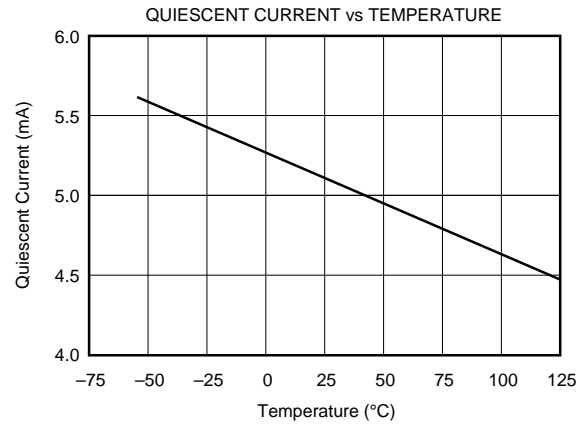
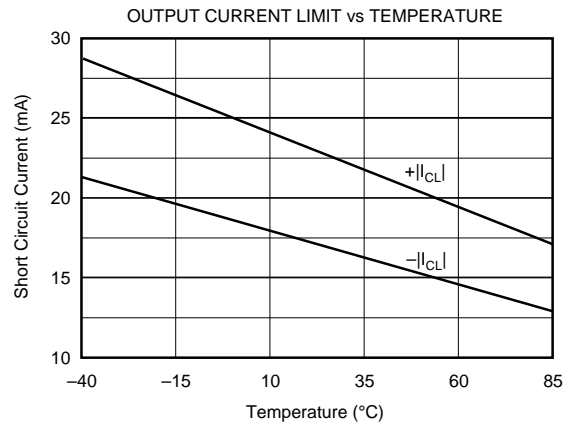
TYPICAL PERFORMANCE CURVES (CONT)

At $T_A = +25^\circ\text{C}$, and $V_S = \pm 15\text{V}$, unless otherwise noted.



TYPICAL PERFORMANCE CURVES (CONT)

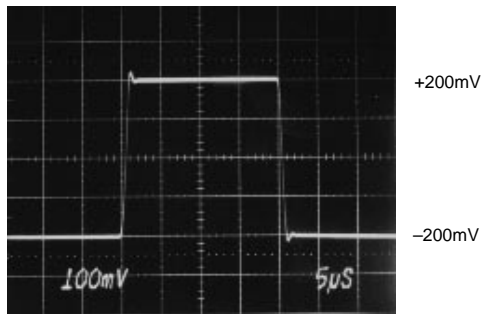
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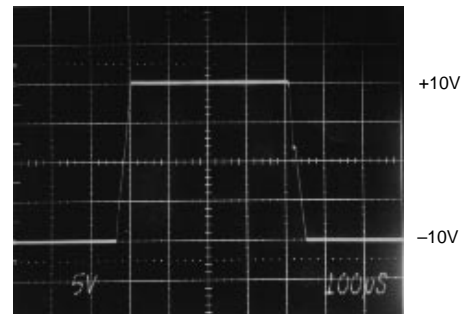
TYPICAL PERFORMANCE CURVES (CONT)

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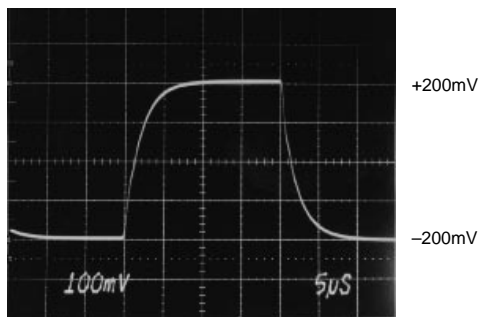
SMALL-SIGNAL RESPONSE, $G = 1$



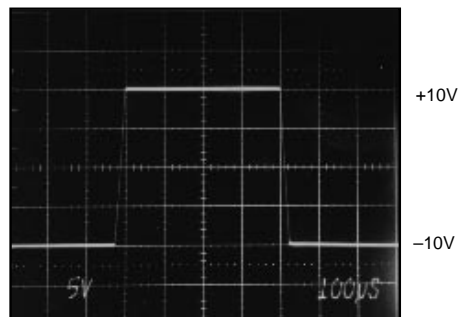
LARGE-SIGNAL RESPONSE, $G = 1$



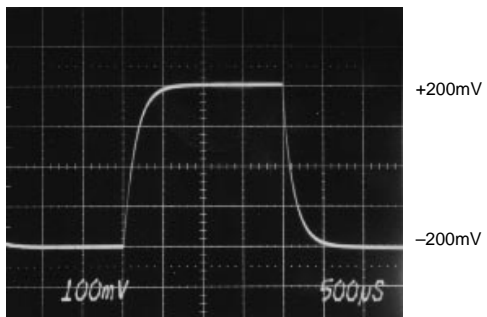
SMALL-SIGNAL RESPONSE, $G = 10$



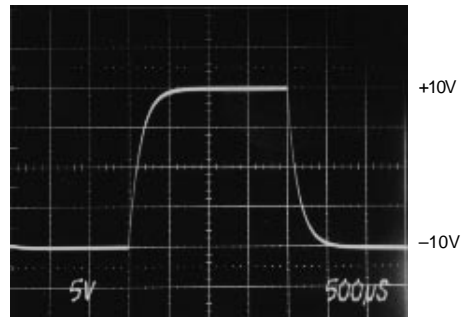
LARGE-SIGNAL RESPONSE, $G = 10$



SMALL-SIGNAL RESPONSE, $G = 1000$

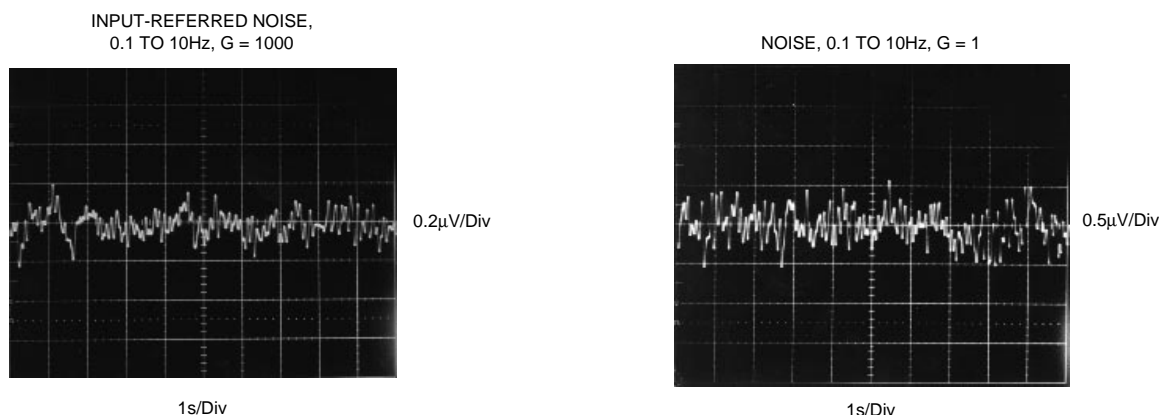


LARGE-SIGNAL RESPONSE, $G = 1000$



TYPICAL PERFORMANCE CURVES (CONT)

At $T_A = +25^\circ\text{C}$, and $V_S = \pm 15\text{V}$, unless otherwise noted.



APPLICATION INFORMATION

Figure 1 shows the basic connections required for operation of the PGA204/205. Applications with noisy or high impedance power supplies may require decoupling capacitors close to the device pins as shown.

The output is referred to the output reference (Ref) terminal which is normally grounded. This must be a low-impedance connection to assure good common-mode rejection. A resistance of 5Ω in series with the Ref pin will cause a typical device to degrade to approximately 80dB CMR ($G=1$).

The PGA204/205 has an output feedback connection (pin 12). Pin 12 must be connected to the output terminal (pin 11) for proper operation. The output Feedback connection can

be used to sense the output voltage directly at the load for best accuracy.

DIGITAL INPUTS

The digital inputs A_0 and A_1 select the gain according to the logic table in Figure 1. Logic “1” is defined as a voltage greater than 2V above digital ground potential (pin 14). Digital ground can be connected to any potential from the V_- power supply to 4V less than V_+ . Digital ground is normally connected to ground. The digital inputs interface directly CMOS and TTL logic components.

Approximately $1\mu\text{A}$ flows out of the digital input pins when a logic “0” is applied. Logic input current is nearly zero with a logic “1” input. A constant current of approximately

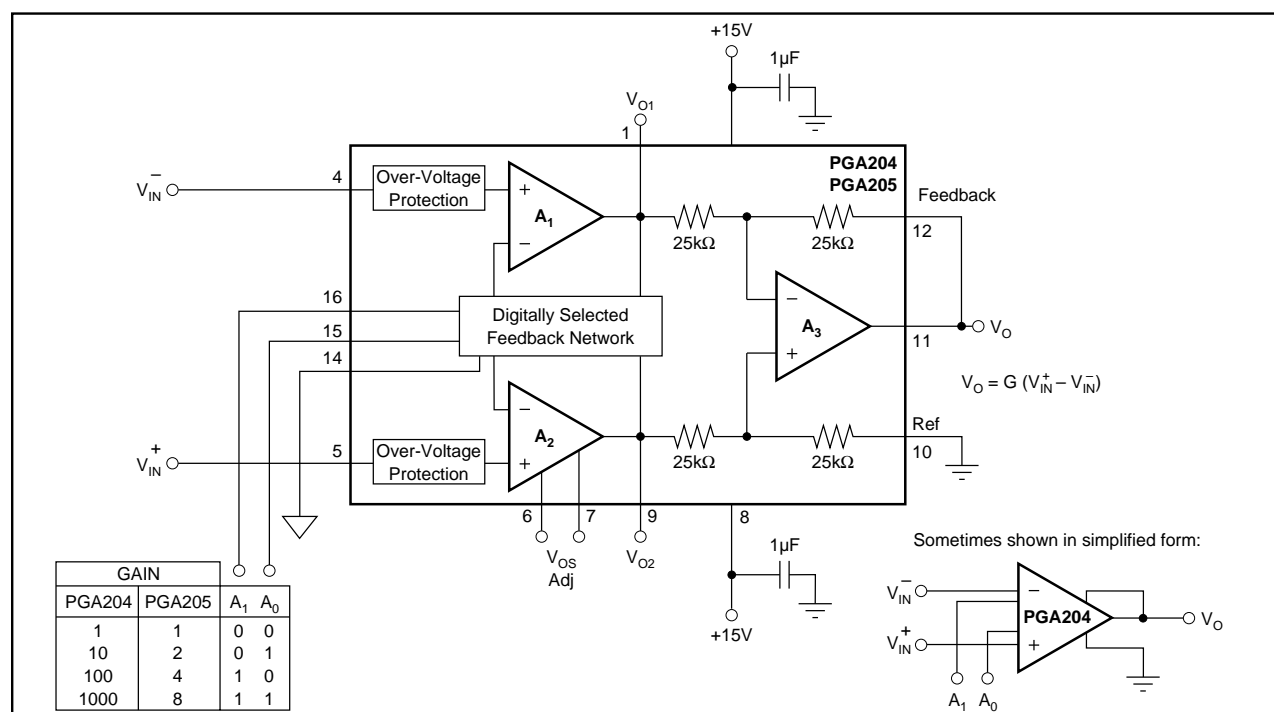


FIGURE 1. Basic Connections.

it to its highest gain and trimming the output voltage to zero with the inputs grounded. Drift performance usually improves slightly when the input offset is nulled with this procedure.

Do not use the input offset adjustment to trim system offset or offset produced by a sensor. Nulling offset that is not produced by the input amplifiers will increase temperature drift by approximately $3.3\mu\text{V}/^\circ\text{C}$ per 1mV of offset adjustment.

Many applications that need input stage offset adjustment do not need output stage offset adjustment. Figure 3 also shows a circuit for adjusting output offset voltage. First, adjust the input offset voltage as discussed above. Then program the device for $G=1$ and adjust the output to zero. Because of the interaction of these two adjustments at $G=8$, the PGA205 may require iterative adjustment.

The output offset adjustment can be used to trim sensor or system offsets without affecting drift. The voltage applied to the Ref terminal is summed with the output signal. Low impedance must be maintained at this node to assure good common-mode rejection. This is achieved by buffering the trim voltage with an op amp as shown.

NOISE PERFORMANCE

The PGA204/205 provides very low noise in most applications. Low frequency noise is approximately $0.4\mu\text{Vp-p}$ measured from 0.1 to 10Hz. This is approximately one-tenth the noise of “low noise” chopper-stabilized amplifiers.

INPUT BIAS CURRENT RETURN PATH

The input impedance of the PGA204/205 is extremely high—approximately $10^{10}\Omega$. However, a path must be provided for the input bias current of both inputs. This input bias current is typically less than $\pm 1\text{nA}$ (it can be either polarity due to cancellation circuitry). High input impedance means that this input bias current changes very little with varying input voltage.

Input circuitry must provide a path for this input bias current if the PGA204/205 is to operate properly. Figure 4 shows provisions for an input bias current path. Without a bias current return path, the inputs will float to a potential which exceeds the common-mode range of the PGA204/205 and the input amplifiers will saturate. If the differential source resistance is low, bias current return path can be connected to one input (see thermocouple example in Figure 4). With higher source impedance, using two resistors provides a balanced input with possible advantages of lower input offset voltage due bias current and better common-mode rejection.

Many sources or sensors inherently provide a path for input bias current (e.g. the bridge sensor shown in Figure 4). These applications do not require additional resistor(s) for proper operation.

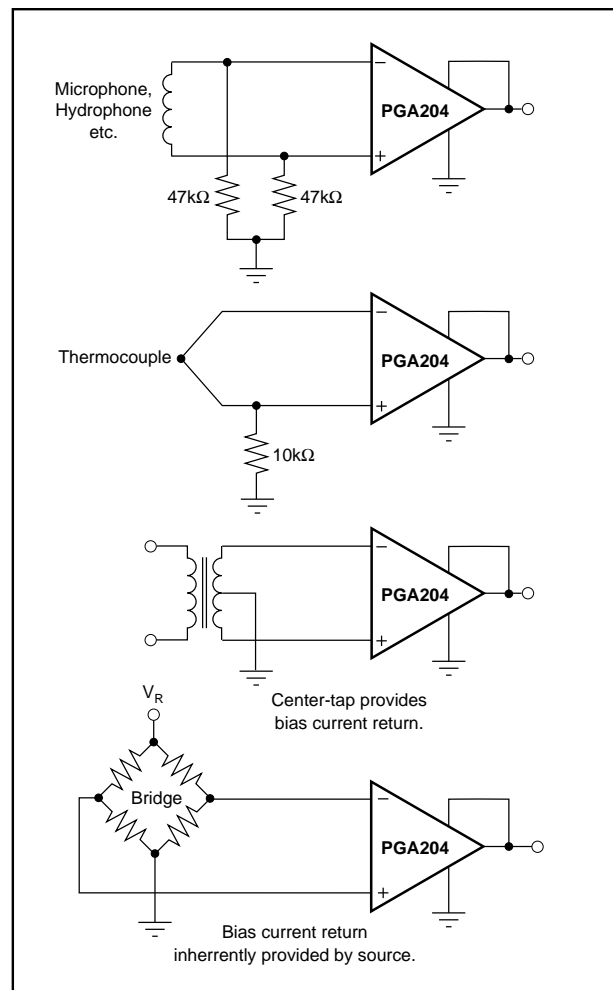


FIGURE 4. Providing an Input Common-Mode Current Path.

INPUT COMMON-MODE RANGE

The linear common-mode range of the input op amps of the PGA204/205 is approximately $\pm 12.7\text{V}$ (or 2.3V from the power supplies). As the output voltage increases, however, the linear input range will be limited by the output voltage swing of the input amplifiers, A_1 and A_2 . The common-mode range is related to the output voltage of the complete amplifier—see performance curve “Input Common-Mode Range vs Output Voltage”.

A combination of common-mode and differential input voltage can cause the output of A_1 or A_2 to saturate. Figure 5 shows the output voltage swing of A_1 and A_2 expressed in terms of a common-mode and differential input voltages. Output swing capability of these internal amplifiers is the same as the output amplifier, A_3 . For applications where input common-mode range must be maximized, limit the output voltage swing by selecting a lower gain of the PGA204/205 (see performance curve “Input Common-Mode Voltage Range vs Output Voltage”). If necessary, add gain after the PGA204/205 to increase the voltage swing.

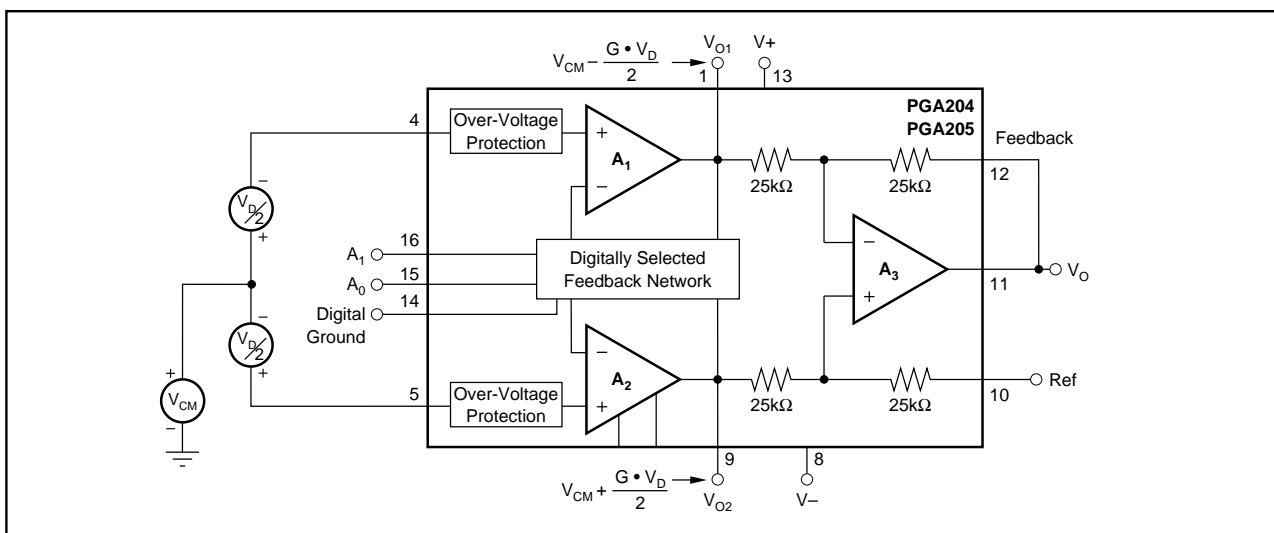


FIGURE 5. Voltage Swing of A₁ and A₂.

Input-overload often produces an output voltage that appears normal. For example, consider an input voltage of +20V on one input and +40V on the other input will obviously exceed the linear common-mode range of both input amplifiers. Since both input amplifiers are saturated to the nearly the same output voltage limit, the difference voltage measured by the output amplifier will be near zero. The output of the PGA204/205 will be near 0V even though both inputs are overloaded.

INPUT PROTECTION

The inputs of the PGA204/205 are individually protected for voltages up to $\pm 40V$. For example, a condition of $-40V$ on one input and $+40V$ on the other input will not cause damage. Internal circuitry on each input provides low series impedance under normal signal conditions. To provide equivalent protection, series input resistors would contribute excessive noise. If the input is overloaded, the protection circuitry limits the input current to a safe value (approximately 1.5mA). The typical performance curve "Input Bias Current vs Common-Mode Input Voltage" shows this input current limit behavior. The inputs are protected even if no power supply voltage is present.

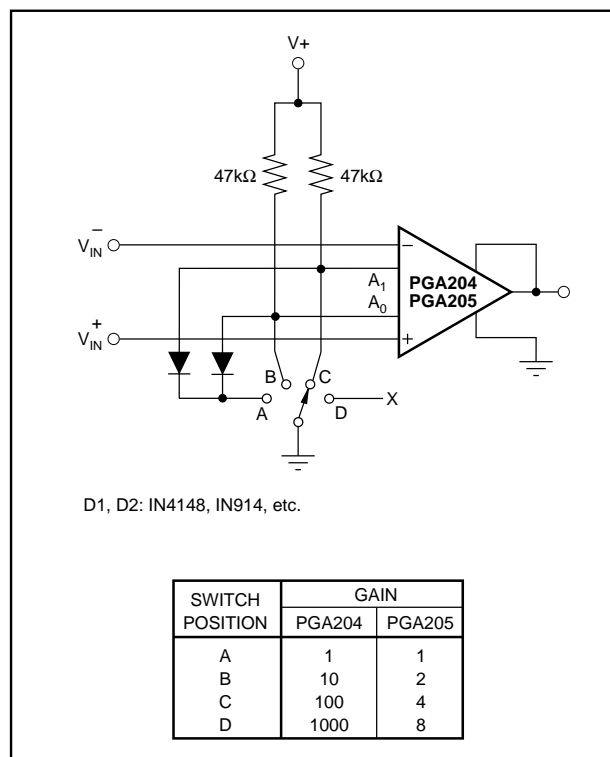


FIGURE 6. Switch-Selected PGIA.

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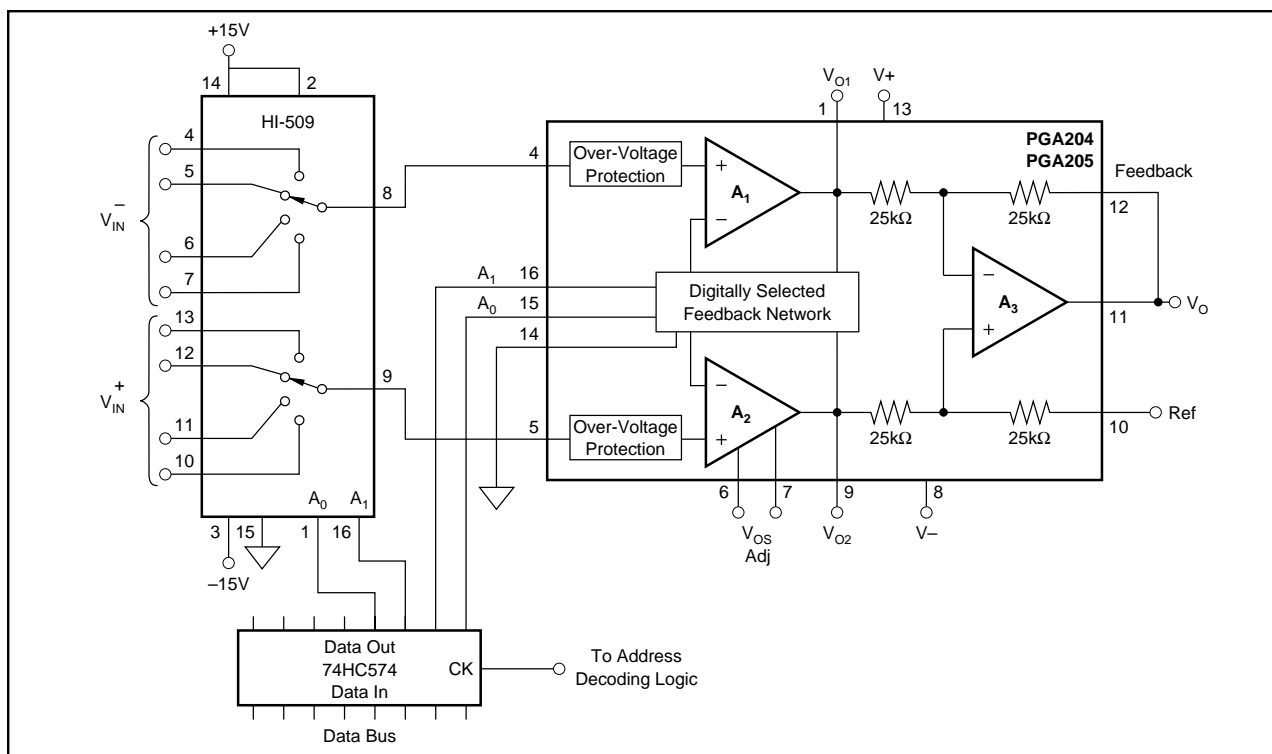


FIGURE 7. Multiplexed-Input Programmable Gain IA.

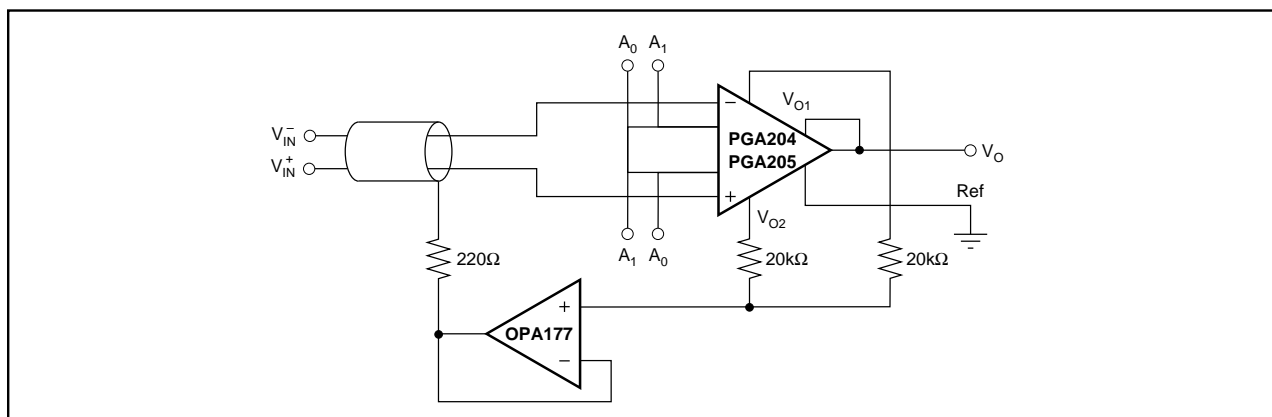


FIGURE 8. Shield Drive Circuit.

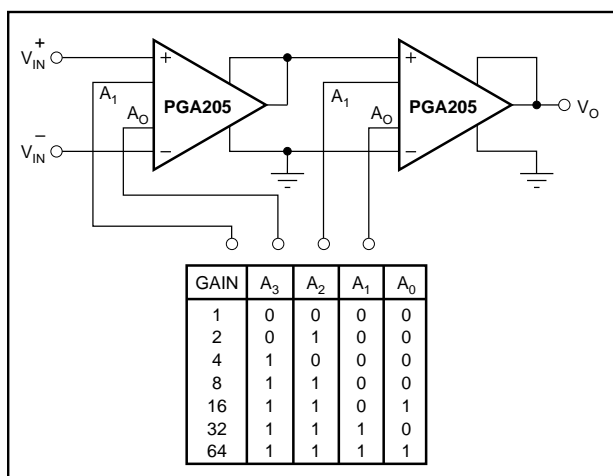


FIGURE 9. Binary Gain Steps, G=1 to G=64.

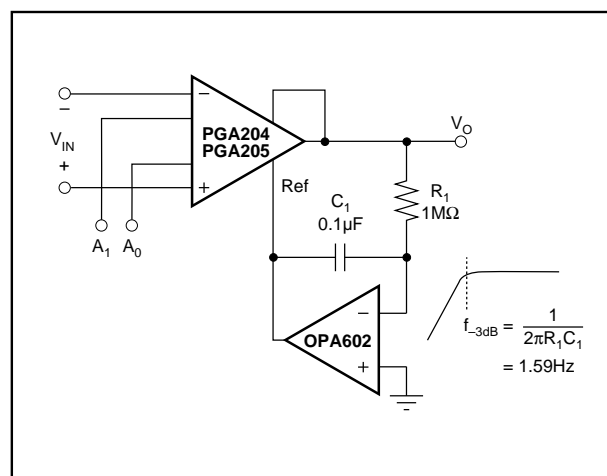


FIGURE 10. AC-Coupled PGIA.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
PGA204AP	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		PGA204AP	Samples
PGA204APG4	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		PGA204AP	Samples
PGA204AU	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	PGA204AU	Samples
PGA204AU/1K	ACTIVE	SOIC	DW	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	PGA204AU	Samples
PGA204AU/1KE4	ACTIVE	SOIC	DW	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	PGA204AU	Samples
PGA204AUE4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	PGA204AU	Samples
PGA204AUG4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	PGA204AU	Samples
PGA204BP	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		PGA204BP	Samples
PGA204BPG4	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		PGA204BP	Samples
PGA204BU	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA204BU	Samples
PGA204BU/1K	ACTIVE	SOIC	DW	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA204BU	Samples
PGA204BU/1KE4	ACTIVE	SOIC	DW	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA204BU	Samples
PGA204BUE4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA204BU	Samples
PGA205AP	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		PGA205AP	Samples
PGA205APG4	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		PGA205AP	Samples
PGA205AU	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA205AU	Samples
PGA205AU/1K	ACTIVE	SOIC	DW	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA205AU	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
PGA205AU/1KG4	ACTIVE	SOIC	DW	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA205AU	Samples
PGA205AUG4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA205AU	Samples
PGA205BP	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		PGA205BP	Samples
PGA205BPG4	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		PGA205BP	Samples
PGA205BU	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA205BU	Samples
PGA205BUG4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PGA205BU	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PGA204AU/1K	SOIC	DW	16	1000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
PGA204BU/1K	SOIC	DW	16	1000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
PGA205AU/1K	SOIC	DW	16	1000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PGA204AU/1K	SOIC	DW	16	1000	367.0	367.0	38.0
PGA204BU/1K	SOIC	DW	16	1000	367.0	367.0	38.0
PGA205AU/1K	SOIC	DW	16	1000	367.0	367.0	38.0

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